

FDMS86101 N-Channel PowerTrench[®] MOSFET 100 V, 60 A, 8 m Ω

Features

- Max $r_{DS(on)}$ = 8 m Ω at V_{GS} = 10 V, I_D = 13 A
- Max r_{DS(on)} = 13.5 mΩ at V_{GS} = 6 V, I_D = 9.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- 100% Rg tested
- RoHS Compliant

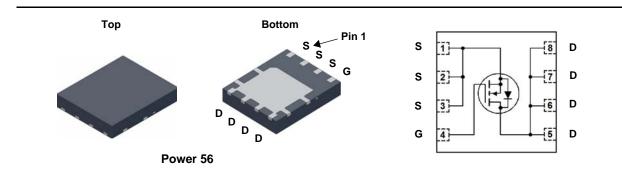


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame		Ratings	Units		
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C		60		
	-Continuous	T _A = 25 °C	(Note 1a)	12.4	Α	
	-Pulsed			200		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	173	mJ	
P _D	Power Dissipation	T _C = 25 °C		104	W	
	Power Dissipation $T_A = 25 \degree C$ (Note 1a)			2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

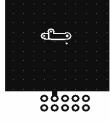
Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86101	FDMS86101	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	N	lin	Тур	Max	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	1	00			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to	o 25 °C		66		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V				800	nA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA
On Chara	cteristics		i				
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to	o 25 °C		-9		mV/°C
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 13 A			6.3	8	mΩ
r _{DS(on)}		$V_{GS} = 6 V, I_D = 9.5 A$			8.4	13.5	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$			10.9	14	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$			45		S
C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	− V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz			2255 460 30	3000 610 45	pF pF pF
R _g	Gate Resistance		0	.1	1.0	3.0	Ω
Switching	Characteristics		i.				
t _{d(on)}	Turn-On Delay Time				15	27	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 13 A,			11	20	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω			27	44	ns
t _f	Fall Time	_			7	13	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V			39	55	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 5 V V_{DD} =	50 V,		22	31	nC
Q _{gs}	Gate to Source Charge	I _D = 13	3 A		9.5		nC
Q _{gd}	Gate to Drain "Miller" Charge				10.8		nC
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	00 0	(Note 2)		0.7	1.2	v
		V_{GS} = 0 V, I _S = 13 A	(Note 2)		0.8	1.3	
t _{rr}	Reverse Recovery Time	– I _F = 13 A, di/dt = 100 A/μs			56	90	ns
Q _{rr}	Reverse Recovery Charge				61	98	nC



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

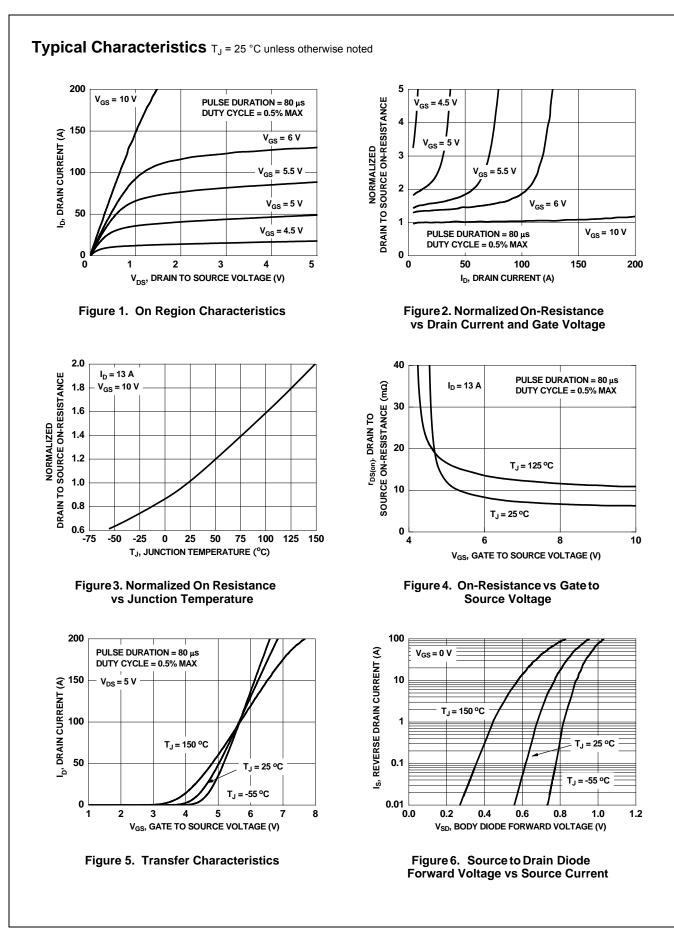
a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

3. E_{AS} of 173 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 34 A, V_{DD} = 75 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 49 A.

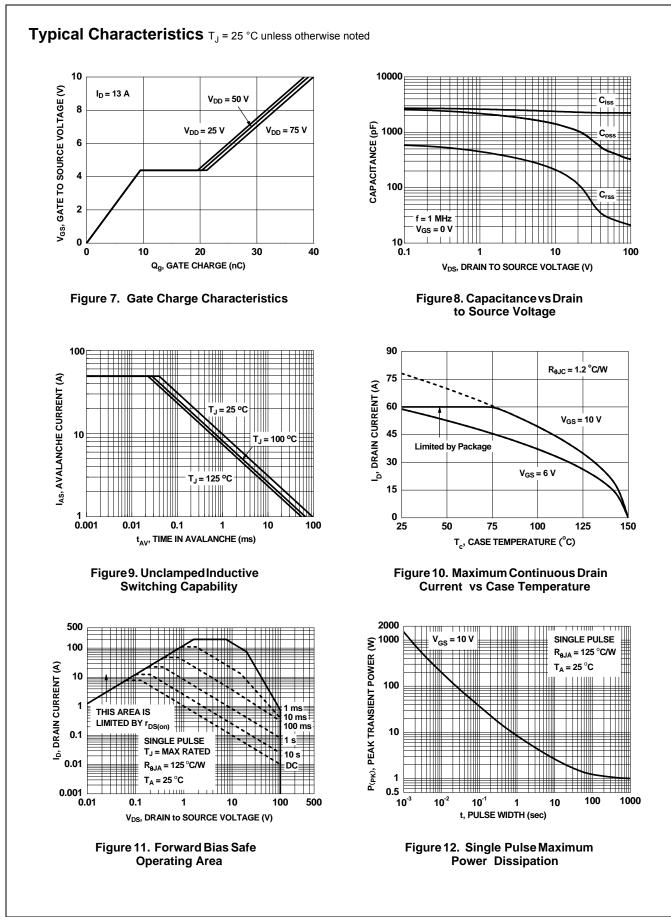


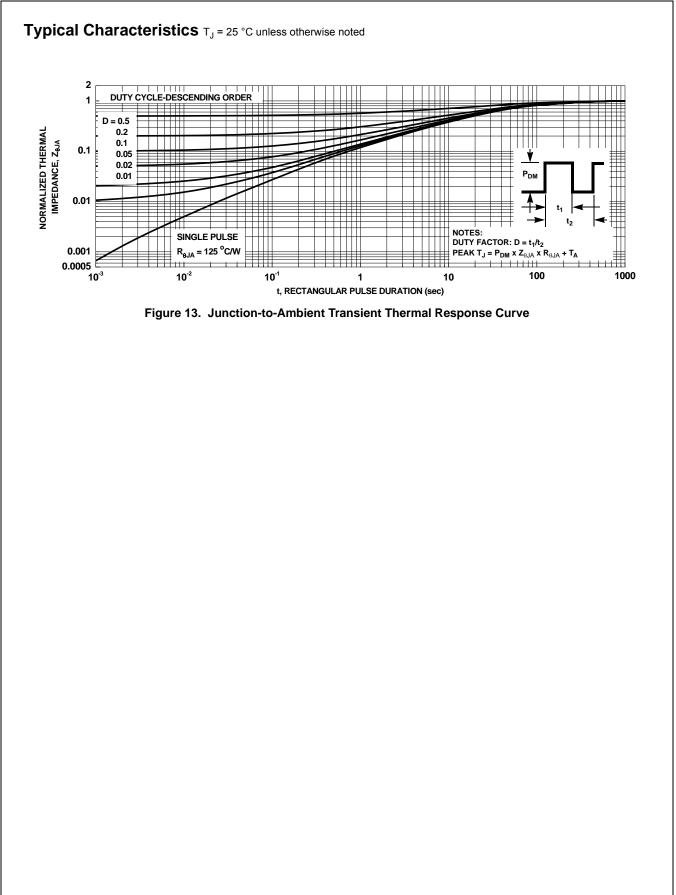
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

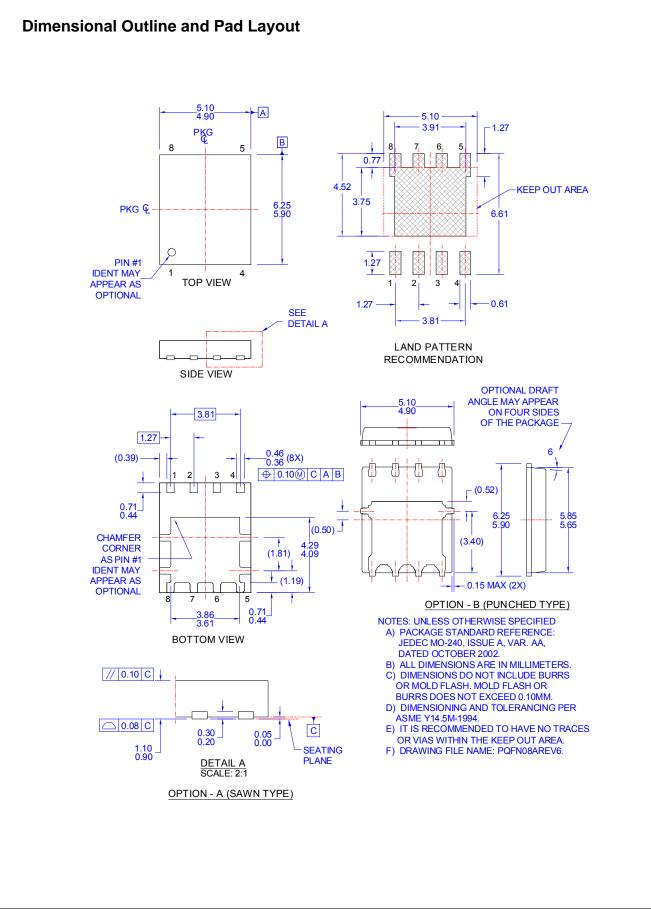














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